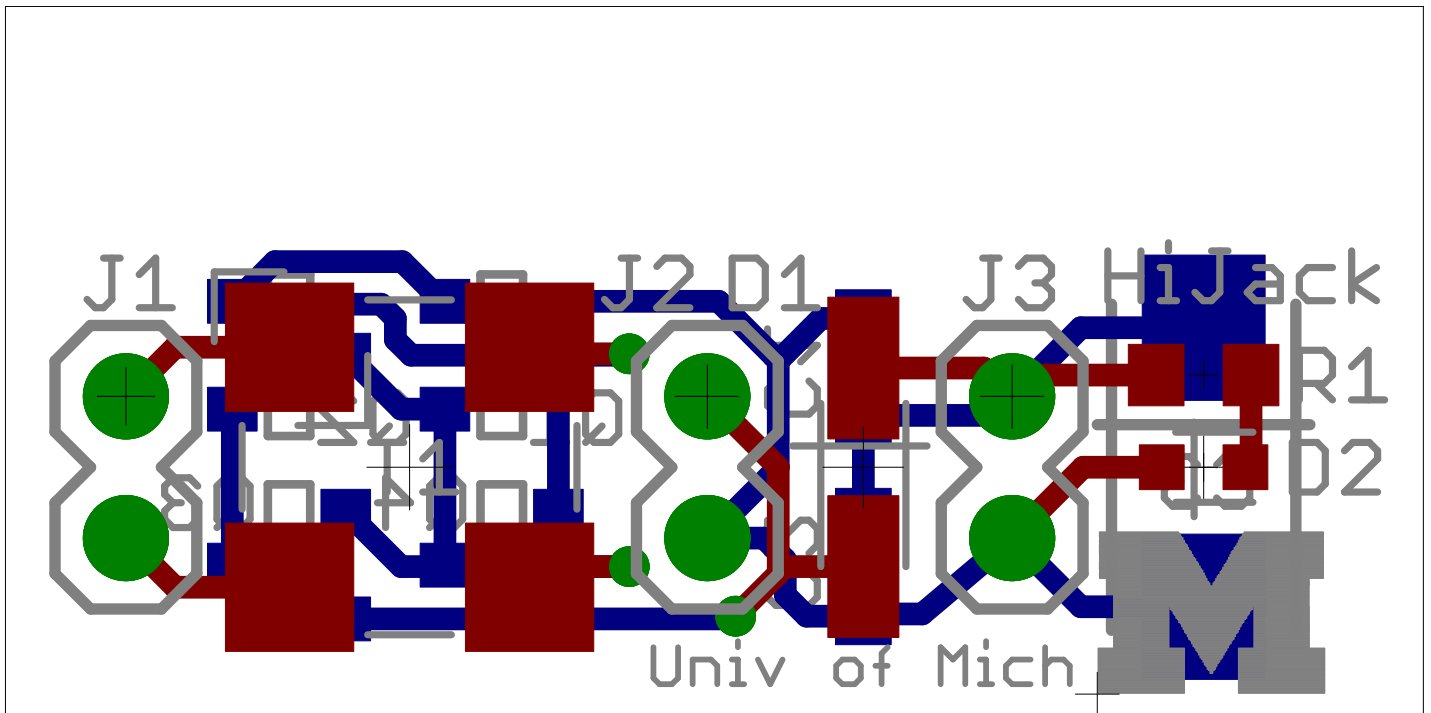
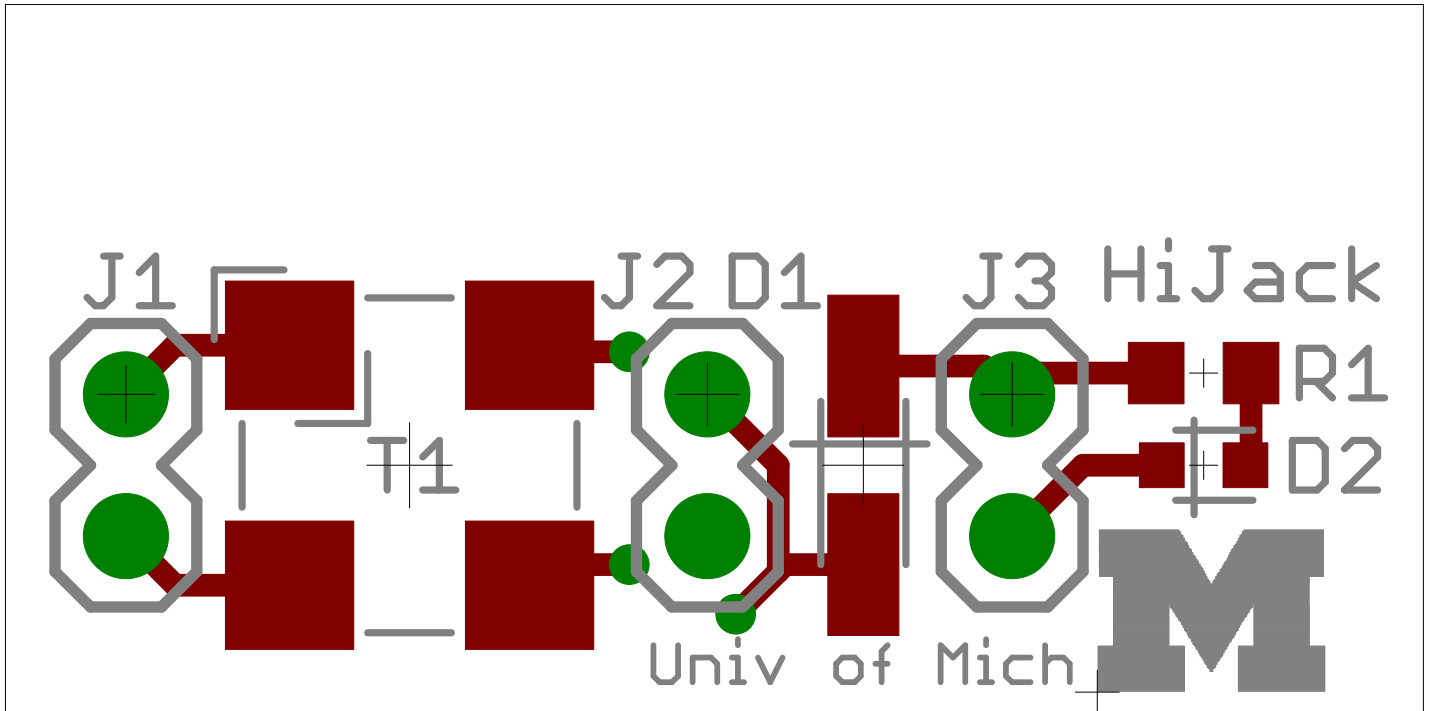


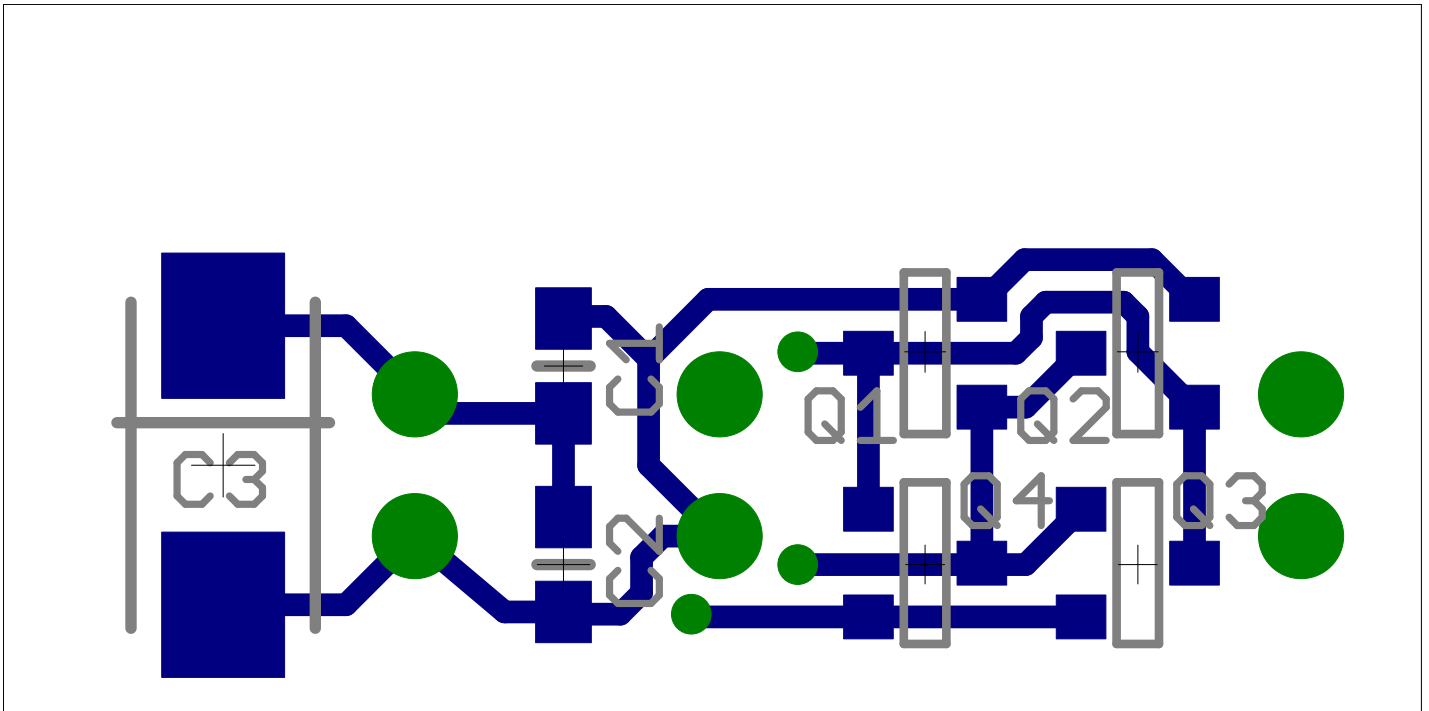
Prabal Dutta / University of Michigan	
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Date: 1/9/14 11:47 PM	Sheet: 1/1

Top and Bottom Layers

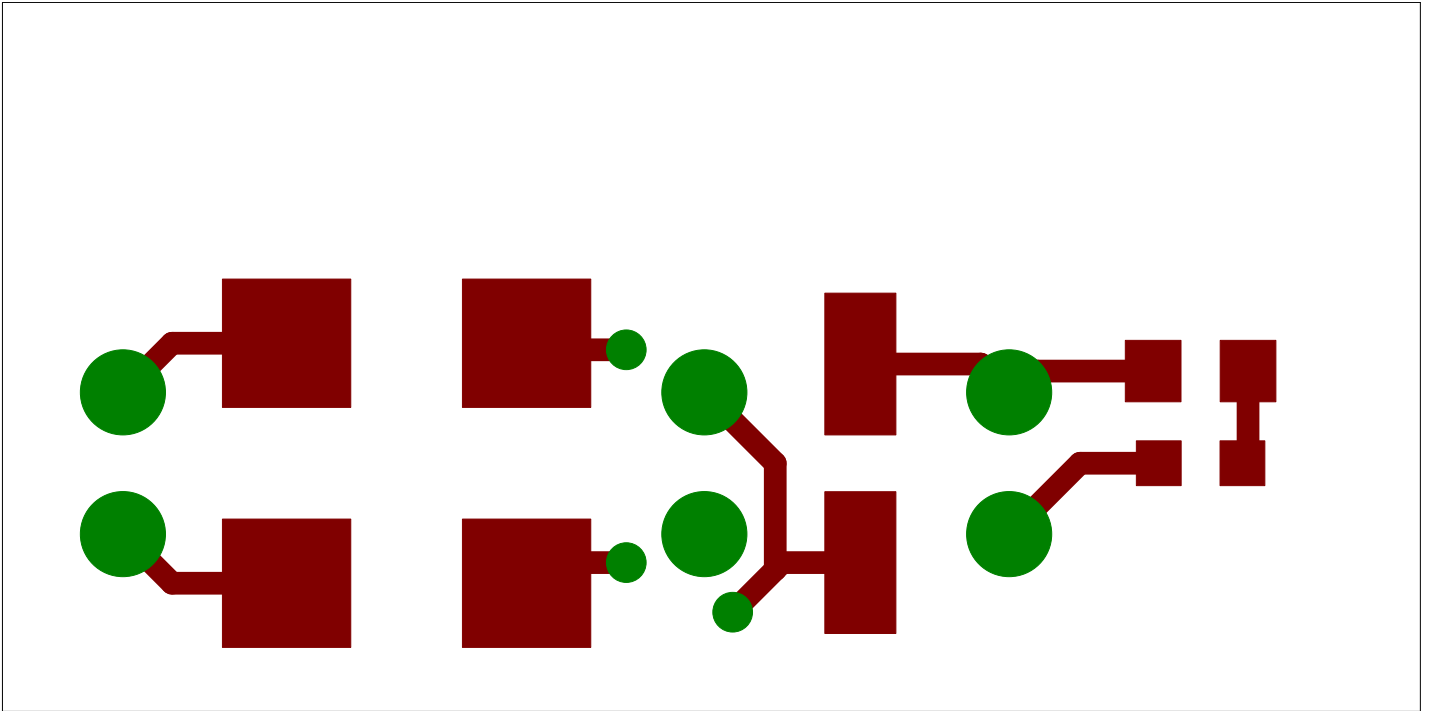




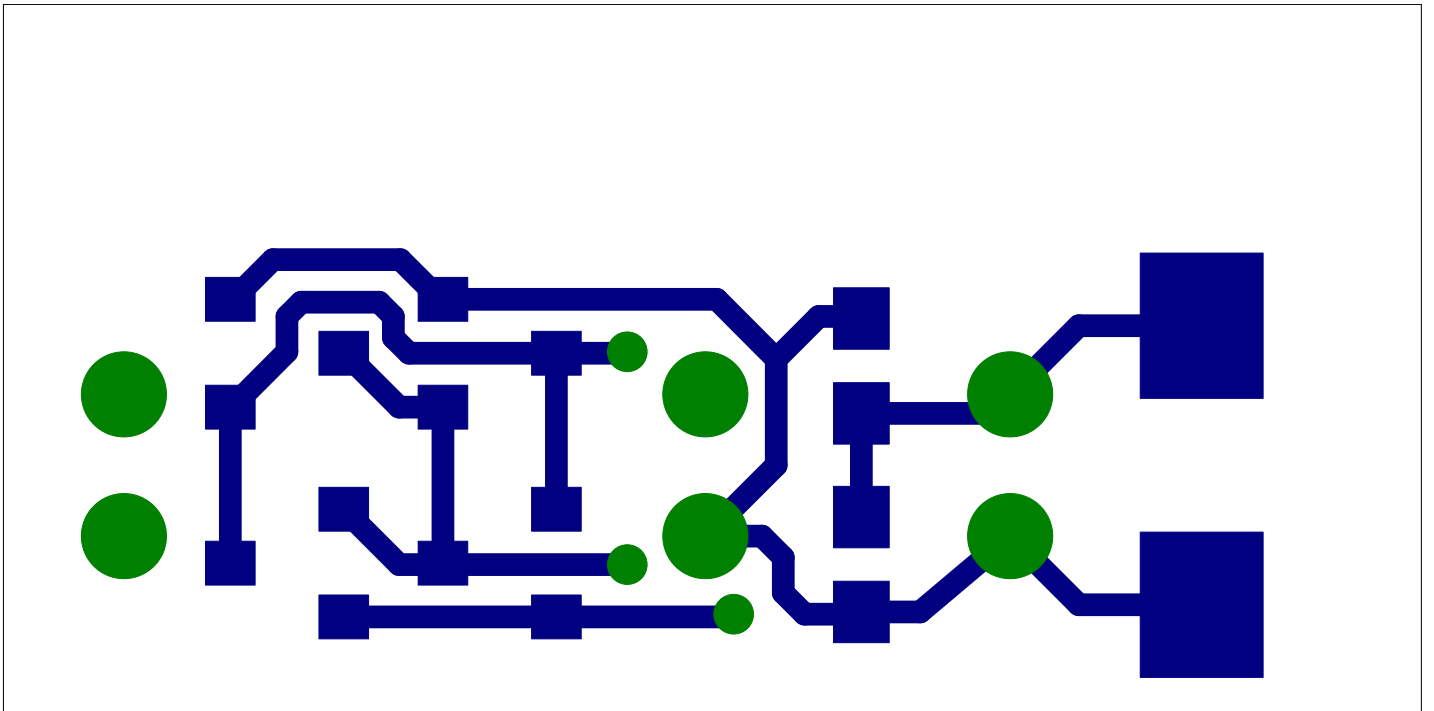
Bottom Layer

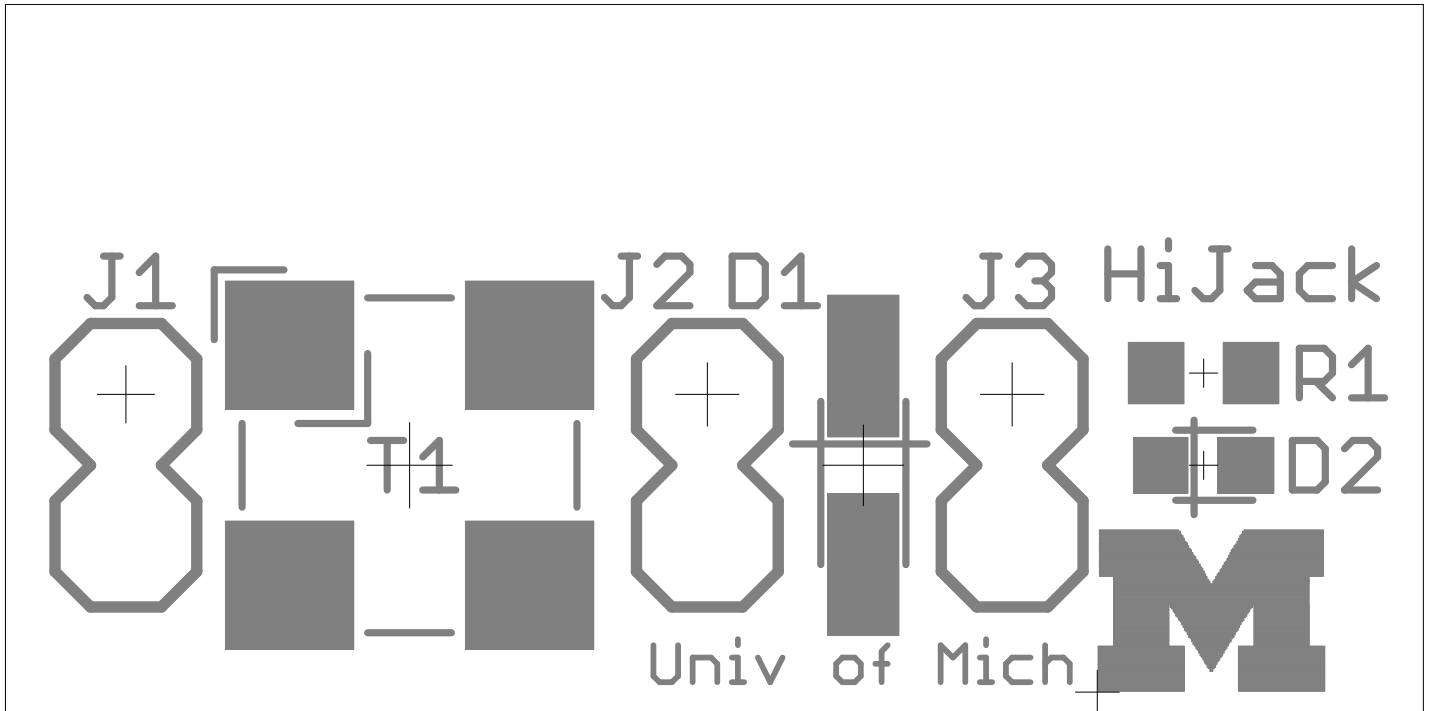


Top Copper Layer

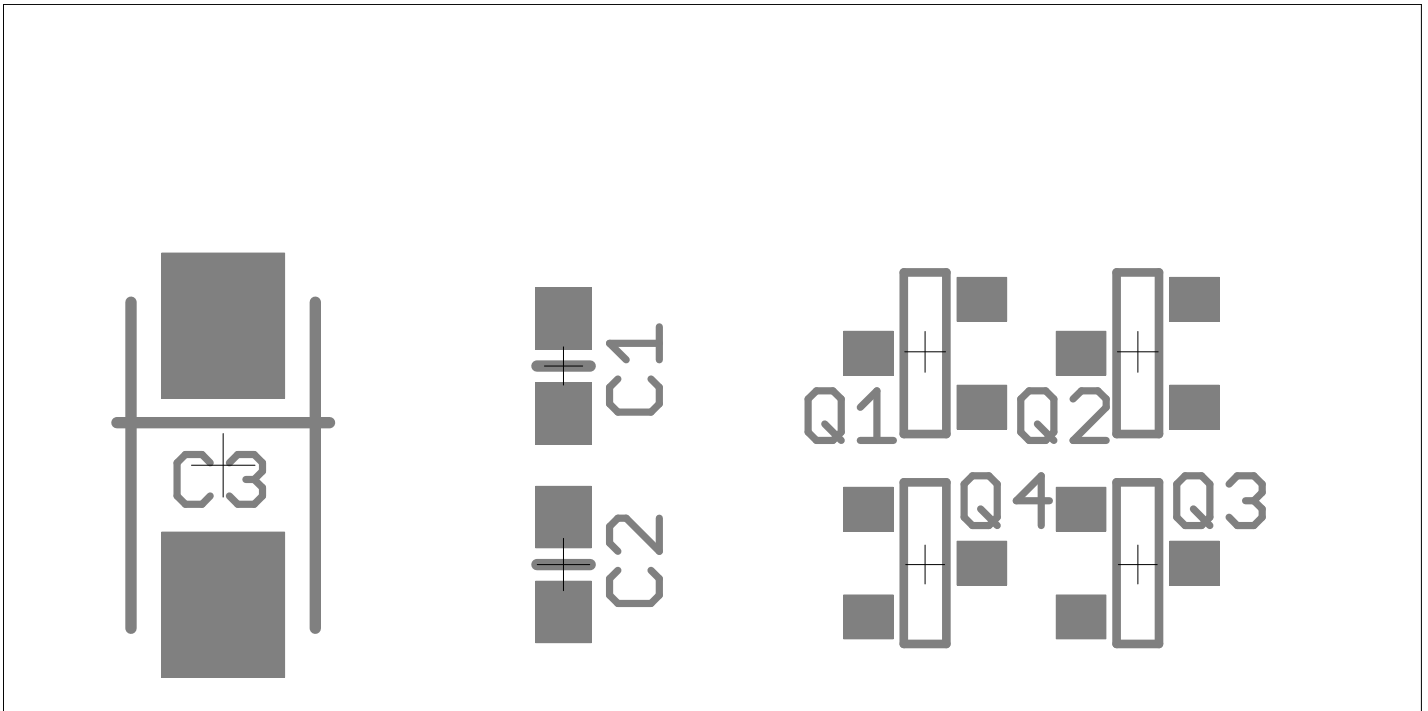


Bottom Copper Layer

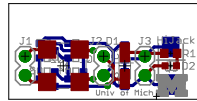


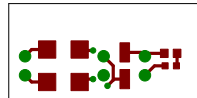


Bottom Paste Layer with Silkscreen



Top and Bottom Layers 1:1 Scale





Bottom Copper Layer 1:1 Scale

